



2 nd Year, 2 nd Term					
Course Code	Course Title	L	T	P	C
Theory					
CSE 2227	Programing Techniques	3	0	0	3
Math 2227	Statistics and Numerical Analysis	3	0	0	3
MSE 2201	Phase Diagrams and Transformations	3	0	0	3
MSE 2203	Mechanical Behavior of Materials	3	0	0	3
Ph 2227	Basic Quantum Mechanics and Solid State Physics	3	0	0	3
Sessional					
CSE 2228	Sessional on Programing Techniques	0	0	3	1.5
MSE 2208	Materials Testing Sessional	0	0	3	1.5
MSE 2206	Compositional and Microstructural Analysis	0	0	3	1.5
Total					19.5

Distribution of Marks

i. Theory Courses:

Class participation, attendance and assignments	10 %
Class tests, Quizzes, Spot tests etc.	20%
Term Final Examination	70%
Total	100%

N.B. Students fail to attend 60% of the class will not allow to sit in the final exam in any circumstance.

ii. Independent laboratory/design/field work courses:

Class participation and attendance	10 %
Quizzes, Viva-Voce conducted in lab class	20%
Viva-Voce conducted centrally	20%
Performance and reports	50%
Total	100%

iii. Project/thesis (Continued for two terms):

a) At the end of 4th year 1st Term: 30% of the total marks to be evaluated as follows:

Presentation and (Viva-Voce conducted by a Viva-Voce committee)	10%
Supervisor	20%
Total	30%

b) At the end of 4th year 2nd Term: 70% of the total marks to be evaluated as follows:

Presentation and Viva-Voce (conducted by a Viva-Voce committee)	20%
Supervisor	40%
External examiner (any other teacher of the department/ a member of examination committee)	10%
Total	70%



2nd Year, 2nd Term

CSE 2227 Programing Techniques

Credit: 3.00

Contact hour: 3 hrs/wk

Referred Textbooks:

- "Programming in ANSI C", by Balagurusamy, Tata McGraw-Hill Education.
- "The C Programming Language" by Brian W. Kernighan, Dennis M. Ritchie
- "Problem Solving with C++: The Object of Programming" by Walter Savitch, 8th Edition.
- "Object Oriented Programming with C++" by E Balaguruswamy.

Contents:

Introduction: Programming languages, Basic program syntax; Programming techniques: Structured (C programming Language) and Object Oriented Programming (C++ programming Language).

Structured Programming: Declaring variables and data types, Basic program structure, Input / output operations, Basic Operators, Control Statements, Conditional statements, Loops, Functions - declarations and calling, Strings, Pointers, Dynamic Memory allocation.

Object Oriented Programming: Introduction to Classes and Objects; File handling; Structure and Union.

Math 2227 Statistics and Numerical Analysis

Credit: 3.00

Contact hour: 3 hrs/wk

Referred Textbooks:

- "Probability and Statistics for Engineers" by Richard A. Johnson, Irwin Miller, John Freund.
- "Statistics" by David Freedman, Robert Pisani, Roger Purves.
- "Introductory Statistics" Prem S. Mann, ISBN: 978-1-119-24894-1.
- "Numerical Methods" by Douglas Faires, Richard Burden, ISBN: 9780495114765.
- "Numerical Methods and Modelling for Engineering" by Khoury, Richard, Harder, Douglas Wilhelm.
- "Numerical Analysis for Engineers: Methods and Applications" by Bilal Ayyub, Richard H. McCuen.

Contents:

Statistics: Overview of the measures of central tendency and dispersion; Moments, skewness and kurtosis; Elementary probability theory, random variable and probability distribution, expectation; Discontinuous probability distributions e.g. binomial, Poisson and negative binomial along with their properties and illustrations; Continuous probability distributions, e.g. normal and exponential along with their properties and illustrations; Elementary sampling theory; Estimation; Hypothesis testing of mean; simple Correlation and regression analysis.

Numerical Analysis:

Interpolation: Simple differences, Newton's formulae for forward and backward interpolation, Divided differences, Tables of divided differences, Relation between divided and simple differences, Newton's general interpolation formula, Lagrange's interpolation formula; Inverse interpolation by Lagrange's formula and by successive approximations.

Numerical Differentiation: numerical differentiation by Newton's forward and backward formulae.

Numerical integration: General quadrature formula for equidistant ordinates, Trapezoidal rule, Simpson's rule, Waddle rule, Calculation of errors, Gauss's quadrature formula, Newton's-cotes formula; Curve fitting: Principle of least squares; Linear, curvilinear and polynomial Curve fitting for one independent variables.

Finding of Roots: Regula-Falsi method, Newton-Raphson method, geometrical significance of the methods, convergence of methods; Solution of linear equations by iteration methods, Norm and condition number, Gauss elimination method, Gauss Seidel and Gauss Jordan methods.



Ph 2227 Basic Quantum Mechanics and Solid State Physics

Credit: 3.00

Contact hour: 3 hrs/wk

Referred Textbooks:

- "Quantum Physics of Atoms, Molecules, Solids, Nuclei & Particles" by Robert Eisberg & Robert Resnick, ISBN: 978-0471-873730
- "Introduction to Quantum Mechanics" by Pauling L. and Wilson E.B., McGraw-Hill
- "Nanoscience and Nanotechnology: Fundamentals of frontiers" by M.S. Ramachandara Rao and Shubra Singh.
- "Quantum Mechanics: An Introduction" by Greiner W. Springer-Verlag, ISBN 3-540-58079-4
- "Introduction to Quantum Mechanics" by David Griffith, Cambridge University Press.
- "Principles of Quantum Mechanics" by Shankar, Springer, ISBN: 978-0306-447907
- "Solid State Physics" by Ashcroft N.W. & Mermin N.D., ISBN: 978-0030-839931
- "Fundamentals of Solid State Physics" by Christman J.R., Wiley, ISBN 0-471-81095-9
- "Introduction to Solid State Physics" by Kittel C., Wiley, ISBN 978-0-471-41526-8

Contents:

Basic Quantum Mechanics: Photo-electric effect, Compton Effect, Atom model (Bohr's, Sommerfeld, Vector atom model), Hydrogen atom model, Wave properties of particles, Schrödinger equation, Quantum tunneling; Operator, Simple Harmonic Oscillation, Spherical and Polar co-ordinates.

Nanotechnology: Nanometer; Nanomaterials and nanotechnology; Classification of nanomaterials; Shape and structure of nanomaterials; Quantum well; Quantum dots; Semiconductor nanoparticles.

Solid State Physics: Lattice Vibration, Specific heat, Einstein Model, Debye Model, Free electron theory of metal, Transport properties (Static and Dynamic), Electrical and Thermal conductivity (Hall effect), Electron drift, Electron excitation, Photon excitation, Quantum Process, Quantum confinement effect, Principle, Population inversion, Optical pumping.

LASER: Characteristics and application of LASER (history of LASER), Types of LASER (Ruby, He-Ne gas, Free electron LASER).

MSE 2201 Phase Diagrams and Transformations

Credit: 3.00

Contact hour: 3 hrs/wk

Referred Textbooks:

- "Phase Diagrams: Understanding the Basics" by F.C. Campbell, ASM International.
- "Phase Diagrams in Metallurgy" by F.N. Rhines, McGraw Hill.
- "Ternary Phase Diagrams in Materials Science" by West and Saunders, Maney Publishing.
- "Phase Transformations in Metals and Alloys", by Porter and Easterling, CRC press.

Contents:

Thermodynamics and phase diagrams: definition of few terms- Equilibrium, Phase, Components; Unary systems; Binary systems; Single component systems; Gibbs free energy as a function of temperature; the driving force for solidification; Nonequilibrium cooling.

Binary phase diagrams: A simple phase diagram; Systems with a miscibility gap; Ordered alloys; Simple eutectic systems; Phase diagrams containing intermediate phases; Eutectic morphologies; Solidification and scale of eutectic structures; Competitive growth of dendrites and eutectics; Peritectic systems; The Gibbs phase rule; The lever rule; The effect of temperature on Solid Solubility.

Common example of binary phase diagrams: Aluminum-silicon eutectic system; Phase diagram of ceramics with example; Iron-Iron carbide phase diagram; Phase diagrams of common stainless steel and other non-ferrous systems.



Ternary and multiphase phase diagrams: Introduction to ternary and quaternary systems and associated phase diagrams; The Gibbs triangle and construction rules for ternary phase diagrams; Space model of ternary systems; The Gibbs triangle; Tie lines; Ternary isomorphous systems.

Diffusion: Atomic mechanism of diffusion; Interstitial diffusion; Substitutional diffusion; Atomic mobility.

Solidification: Nucleation in Pure Metals-Homogeneous nucleation, Homogeneous nucleation Rate, Heterogeneous nucleation, Nucleation of melting, Growth of a pure solid; Continuous growth; Lateral growth; Surface nucleation; Alloy solidification; Solidification of single-phase alloys; Nucleation of precipitates from a supersaturated solid solution; Equilibrium solidification; Cellular and dendritic solidification; Eutectic solidification.

Diffusionless Transformation in Solids: Characteristics of diffusionless transformations; The solid solution of carbon in Iron; CCT diagram; Martensite crystallography; The bain model of the fcc~bcc transformation; Comparison of crystallographic theory with experimental results; Theories of martensite nucleation; Martensite growth; Effect of retained austenite; The development of nonequilibrium transition phases due to interfacial energy effects; Coherent, semi-coherent, and incoherent interfaces and energetics.

MSE 2203 Mechanical Behavior of Materials

Credit: 3.00

Contact hour: 3 hrs/wk

Referred Textbooks:

- "Mechanical Behavior of Materials" by B. W. F. Hosford, Cambridge University Press.
- "Mechanical Metallurgy" by Dieter, Wiley.
- "Mechanical Behavior of Materials" by Courtney, T. H. McGraw-Hill.
- "Deformation and Fracture Mechanics of Engineering Materials" by Hertzberg, R. W.
- "Mechanical Behavior of Materials" by Dowling McGraw Hill.
- "Introduction to Dislocations" by Hull and Bacon, Oxford University Press.

Contents:

Elasticity: Isotropic elasticity; Variation of Young's modulus; Isotropic thermal expansion; Elastic anisotropy; Orientation dependence of elasticity

Mechanical Testing: Tensile specimens; Stress-strain curves; Ductility; True stress and strain; Compression test; Plane strain compression; Plane strain tension; Torsion test; Bend tests; Correlation of Hardness and ultimate tensile strength.

Strain Hardening of Metals: Introduction; Mathematical approximations; Power Law approximation; Necking; Work per volume; Localization of strain at defects; Notes; Problems.

Plasticity, Slip and Dislocation: Yield criteria; Von Mises Criterion; Flow rules; Slip systems; Schmid's law; Strains produce by slips; Strain hardening of fcc single crystals; Tensile deformation of fcc crystals; Slip in bcc crystals; Lattice rotation in tension; Lattice rotation in compression; Texture formation in polycrystals; Deformation of polycrystals; Dislocation geometry and energy-Theoretical strength of crystals, The nature of dislocations, Burgers vectors, Energy of a screw dislocation, Reactions between parallel dislocations and Frank's rule, Stress fields around dislocations, Stacking faults, Application of simple dislocation theory to plastic deformation; Dislocation mechanics-Frank-Read sources, Dislocation pile-ups, Cross-slip, Dislocation intersections, Climb;

Fracture mechanics: Basic mechanism of ductile and brittle fracture; Griffith and Orowan theories of ideally brittle fracture; Fracture modes and fractography; Linear-elastic fracture mechanics; Stress concentration and concept of fracture toughness; Fracture mechanics in design; Ductile to Brittle Transition Temperature (DBTT); Factors affecting DBTT; Determination of DBTT

Creep and stress rupture: Creep mechanisms; Structural changes during creep; Temperature dependence of creep; Metallurgical factors affecting creep; Deformation mechanism maps; creep-fatigue; Visco-elasticity; Alloys of high temperature use.

Fatigue: Fatigue failure; Stress cycles, effect of mean stress; Factors affecting fatigue; Structural changes accompanying fatigue; Stress-strain/life description in fatigue (S-N curves, endurance



strengths/fatigue limits; Crack propagation; Goodman relationship, Neuber's and Miner's rules, fatigue strength reduction factors); Low and high cycle fatigue; Application of fracture mechanics to fatigue-crack growth; Fatigue resistant design; Fatigue thresholds.

CSE 2228 Programing Techniques Sessional

Credit: 1.5

Contact hour: 3 hrs/wk

Topics: Laboratory based on CSE 2227

MSE, KUET